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December 2014

FCP190N60E / FCPF190N60E N-Channel SuperFET[®] II Easy-Drive MOSFET



600 V, 20.6 A, 190 mΩ

Features

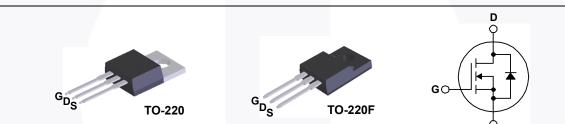
- 650 V @ T_J = 150°C
- Typ. R_{DS(on)} = 160 mΩ
- Ultra Low Gate Charge (Typ. Q_q = 63 nC)
- Low Effective Output Capacitance (Typ. Coss(eff.) = 178 pF)
- 100% Avalanche Tested
- An Integrated Gate Resistor
- RoHS Compliant

Applications

- LCD / LED / PDP TV Lighting
- Solar Inverter
- AC-DC Power Supply

Description

SuperFET[®] II MOSFET is Fairchild Semiconductor's brand-new high voltage super-junction (SJ) MOSFET family that is utilizing charge balance technology for outstanding low on-resistance and lower gate charge performance. This technology is tailored to minimize conduction loss, provide superior switching performance, dv/dt rate and higher avalanche energy. Consequently, SuperFET II MOSFET easy-drive series offers slightly slower rise and fall times compared to the SuperFET II MOSFET series. Noted by the "E" part number suffix, this family helps manage EMI issues and allows for easier design implementation. For faster switching in applications where switching losses must be at an absolute minimum, please consider the Super-FET II MOSFET series.



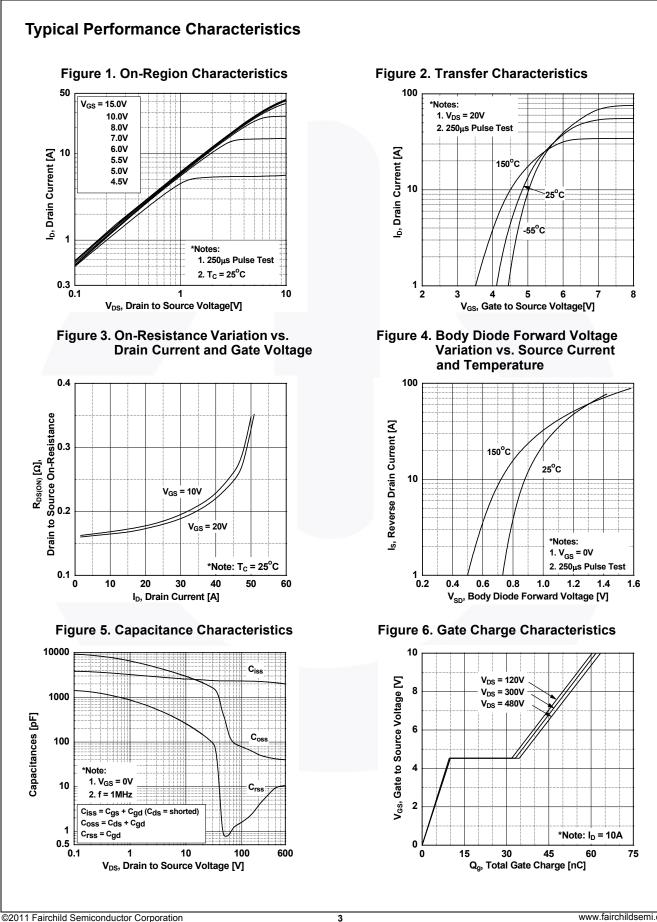
MOSFET Maximum Ratings T_C = 25°C unless otherwise noted.

Symbol		FCP190N60E	FCPF190N60E	Unit		
V _{DSS}	Drain to Source Voltage			6	V	
V _{GSS}	Cata ta Sauraa Valtaga	- DC	- DC			V
	Gate to Source Voltage	- AC	- AC (f > 1 Hz)			V
I _D	Drain Current	- Continuous (T _C = 25°C)	20.6	20.6*	_	
	Drain Current	- Continuous (T _C = 100 ^o C)	13.1	13.1*	A	
I _{DM}	Drain Current	- Pulsed	(Note 1) 61.8 61.8*			Α
E _{AS}	Single Pulsed Avalanche Energy (Note 2)			4	mJ	
I _{AR}	Avalanche Current (1		(Note 1)	4	Α	
E _{AR}	Repetitive Avalanche Energy		(Note 1)	2.1		mJ
dv/dt	MOSFET dv/dt	1	V/ns			
	Peak Diode Recovery dv/dt (No			2	20	v/ns
P _D	Dower Dissinction	$(T_{\rm C} = 25^{\rm o}{\rm C})$		208	39	W
	Power Dissipation	- Derate Above 25°C	1.67	0.31	W/ºC	
T _J , T _{STG}	Operating and Storage Temperature Range			-55 to	°C	
TL	Maximum Lead Temperature for Soldering, 1/8" from Case for 5 Seconds			3	°C	
Drain current	limited by maximum junction temp	perature.				

Thermal Characteristics

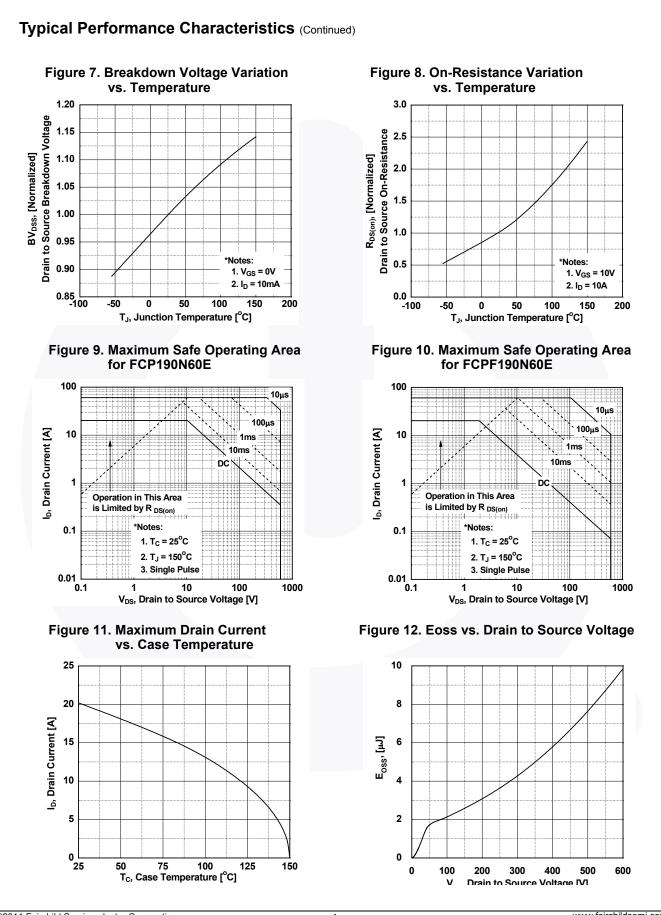
Symbol	Parameter	FCP190N60E	FCPF190N60E	Unit
$R_{ ext{ heta}JC}$	Thermal Resistance, Junction to Case, Max.	0.6	3.2	°C/W
R_{\thetaJA}	Thermal Resistance, Junction to Ambient, Max.	62.5	62.5	0/11

	nber	Top Mark	Packag	je	Packing Method	Reel Siz	e	Tape Wid	th 🛛	Quantity	
FCP190N60E		FCP190N60E	TO-220	0	Tube	N/A		N/A		50 units	
FCPF190N60E		FCPF190N60E	TO-220F		Tube	N/A		N/A		50 units	
Electrica	Char	acteristics T _C = 25°C	C unless	othe	rwise noted.						
Symbol		Parameter			Test Conditions		Min.	Тур.	Max.	Unit	
Off Charac	teristic	S									
BV _{DSS}	Drain to			V _{GS} = 0 V, I _D = 10 mA, T _J = 25°C		600		-	v		
				V_{GS} = 0 V, I_{D} = 10 mA, T_{J} = 150°C			650	-	-		
ΔΒV _{DSS} /ΔΤ _J	Coefficie	own Voltage Temperature ent	۱ _C	$I_D = 10 \text{ mA}, \text{Referenced to } 25^{\circ}\text{C}$		-	0.67	-	V/°C		
BV _{DS}	Drain to Source Avalanche Breakdow		own _V	V _{GS} = 0 V, I _D = 20 A		_	700	_	V		
05	Voltage							100		•	
I _{DSS}	Zero Gate Voltage Drain Current			$V_{DS} = 600 V, V_{GS} = 0 V$ $V_{DS} = 480 V, T_{C} = 125^{\circ}C$			-	-	1	μA	
							-	2.8	-		
IGSS	Gate to Body Leakage Current		V	$V_{GS} = \pm 20 V, V_{DS} = 0 V$			-	-	±100	nA	
On Charac	teristic	S									
V _{GS(th)}	Gate Th	nreshold Voltage	V	GS =	V _{DS} , I _D = 250 μA		2.5	-	3.5	V	
R _{DS(on)}	Static D	rain to Source On Resistan	ice V	V _{GS} = 10 V, I _D = 10 A		-	0.16	0.19	Ω		
9 _{FS}	Forward	d Transconductance	V	bs =	20 V, I _D = 10 A		-	20	-	S	
Dynamic C	haracte	eristics									
C _{iss}	1	apacitance					-	2385	3175	pF	
C _{oss}		Capacitance		— V _{DS} = 25 V, V _{GS} = 0 V, f = 1 MHz		-	1795	2396	pF		
C _{rss}		e Transfer Capacitance	T :			-	110	165	pF		
C _{oss}		Capacitance	V	V _{DS} = 380 V, V _{GS} = 0 V, f = 1 MHz		-	42	-	pF		
C _{oss(eff.)}	Effective	e Output Capacitance		$V_{DS} = 0 V \text{ to } 480 V, V_{GS} = 0 V$		-	178	-	pF		
Q _{g(tot)}	Total Ga	ate Charge at 10V			380 V, I _D = 10 A,		-	63	82	nC	
Q _{gs}	Gate to	Source Gate Charge		$V_{\rm DS} = 360$ V, $T_{\rm D} = 10$ A, $V_{\rm GS} = 10$ V		-	10	-	nC		
Q _{gd}	Gate to	Drain "Miller" Charge		(Note 4)			-	24	-	nC	
ESR	Equivale	alent Series Resistance		f = 1 MHz			-	5	-	Ω	
Switching	Charac	toristics	1								
•		Delay Time					-	22	56		
t _{d(on)}		Rise Time	V	$V_{DD} = 380 \text{ V}, \text{ I}_{D} = 10 \text{ A},$ $V_{GS} = 10 \text{ V}, \text{ R}_{G} = 4.7 \Omega$		-	-	23	56	ns	
t _r							-	14	38 212	ns	
t _{d(off)}		f Delay Time f Fall Time					-	101 15	40	ns	
t _f						(Note 4)	-	15	40	ns	
	-	le Characteristics									
I _S		m Continuous Drain to Sou					-	-	20.2	A	
I _{SM}		aximum Pulsed Drain to Source Diode Forward Current			-	-	60.6	A			
V _{SD}		Source Diode Forward Volt		00 00		-	-	1.2	V		
t _{rr}		Recovery Time		$V_{GS} = 0 V, I_{SD} = 10 A,$		-	308	-	ns		
Q _{rr}	Reverse Recovery Charge $dI_F/dt = 100 A/\mu s$				-	4.8	-	μC			



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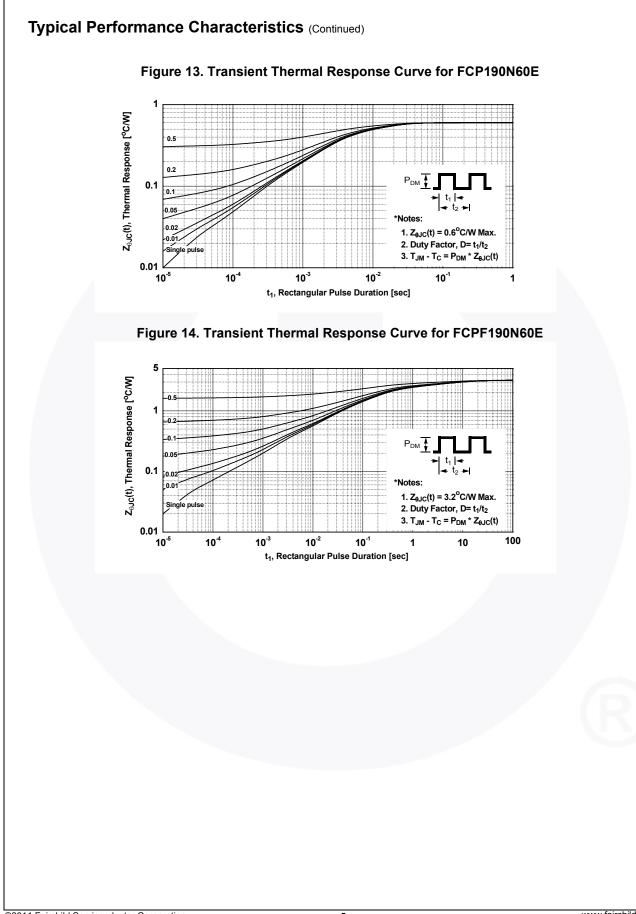
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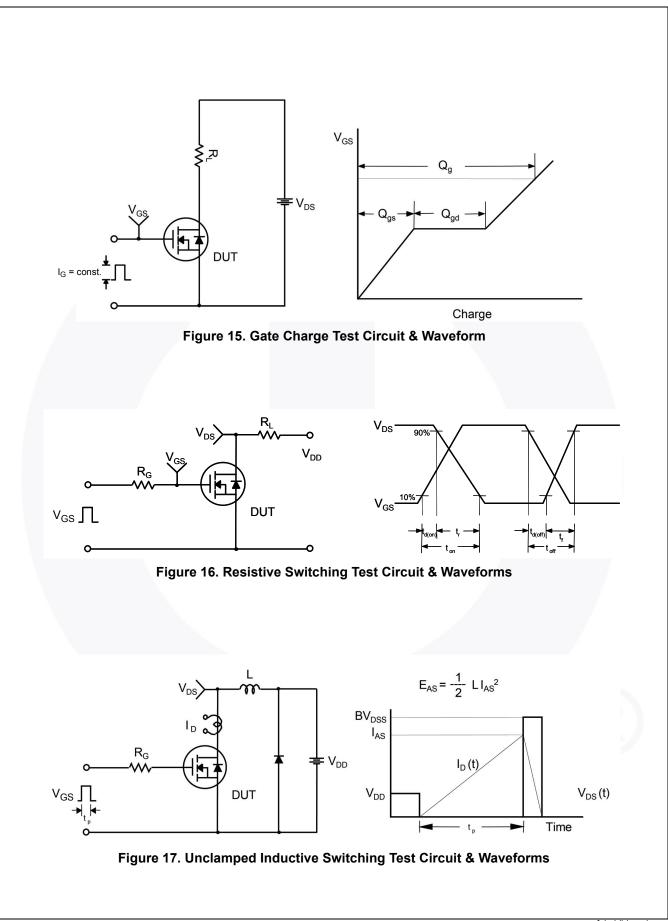
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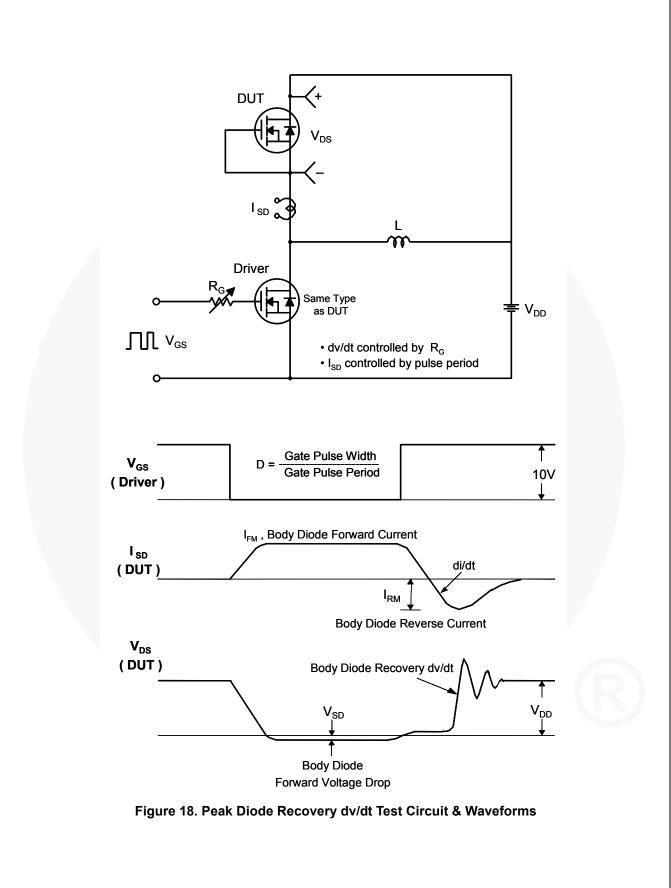


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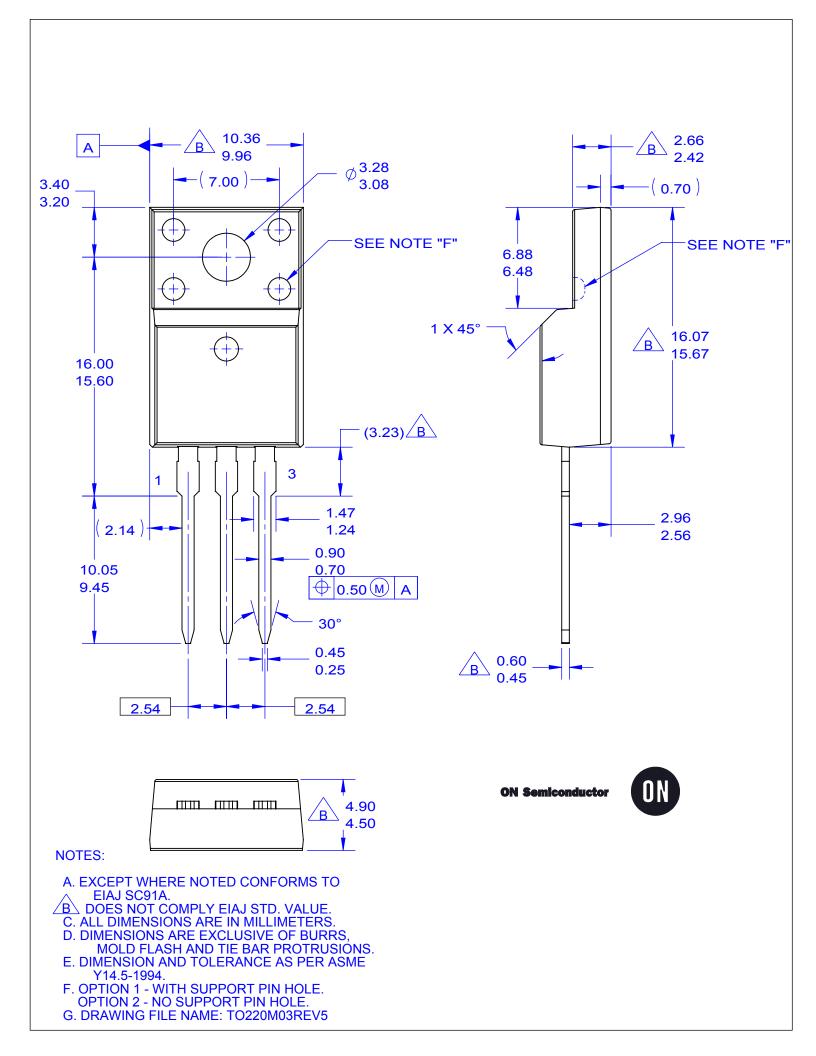


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